

# VS22VUA1LAM

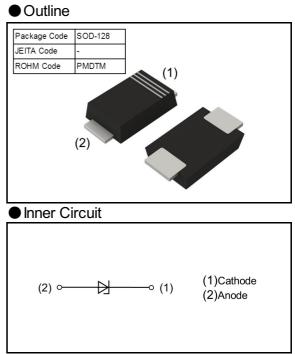
Transient Voltage Suppressor

## Data sheet

V <sub>RVM</sub>	22	V
PfP	600	W
١ <del>٣</del>	16.9	А

Feature

High reliability Small power mold type



#### Packaging Specification

Packing	Embossed Tape
Reel Size(mm)	180
Taping Width(mm)	12
Quantity(pcs)	3000
Taping Code	TR
Marking	W6

Application
Surge Protection

Structure
Silicon Epitaxial Planar

## • Absolute Maximum Rating $(T_a = 25^{\circ}C)$

Parameter	Symbol	Conditions	Min.	Max.	Unit
Peak Pulse Power	P <sub>PP</sub>	tp=10/1000us	-	600	W
Peak Pulse Current	IPP	tp=10/1000us	-	16.9	А
Junction temperature	Тj	-	-	150	°C
Storage temperature	T <sub>stg</sub>	-	-55	150	°C

## VSxxVUA1LAM Series

## ● Characteristic (Ta = 25°C)

	Symbol							
$V_{-}$ Donk(V)	Breakdown voltage :		Reverse Current:		Clamping voltage:		Reverse Stand-off voltage :	
V <sub>Z</sub> Rank(V)	V <sub>BR</sub> (V) <sup>(1)</sup>		l <sub>R</sub> (μΑ)		V <sub>CL</sub> (V)		V <sub>RVM</sub> (V)	
	MN.	MAX.	ң(mA)	MAX.	V <sub>R</sub> (V)	MAX.	Ipp(A)	MAX.
5	6.45	7.14	10	800	5.0	10.5	57.0	5.0
6	6.67	7.37	10	800	6.0	10.3	58.3	6.0
7	7.78	8.60	10	500	7.0	12.0	50.0	7.0
8	8.89	9.83	1	50.0	8.0	13.6	44.1	8.0
9	10.0	11.10	1	5.0	9.0	15.4	39.0	9.0
10	11.1	12.30	1	5.0	10	17.0	35.3	10
11	12.2	13.5	1	5.0	11	18.2	33.0	11
12	13.3	14.7	1	2.5	12	19.9	30.2	12
13	14.4	15.9	1	2.5	13	21.5	28.0	13
14	15.6	17.2	1	2.5	14	23.2	25.9	14
15	16.7	18.5	1	2.5	15	24.4	24.6	15
16	17.8	19.7	1	2.5	16	26.0	23.1	16
17	18.9	20.9	1	2.5	17	27.6	21.7	17
18	20.0	22.1	1	2.5	18	29.2	20.5	18
20	22.2	24.5	1	2.5	20	32.4	18.5	20
22	24.4	26.9	1	2.5	22	35.5	16.9	22
24	26.7	29.5	1	2.5	24	38.9	15.4	24
26	28.9	31.9	1	2.5	26	42.1	14.3	26
28	31.1	34.4	1	2.5	28	45.4	13.2	28
30	33.3	36.8	1	2.5	30	48.4	12.4	30

Note(1) V<sub>BR</sub> test time is 40ms.

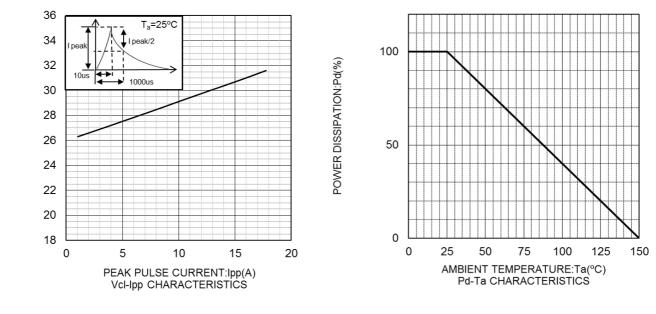
## Marking

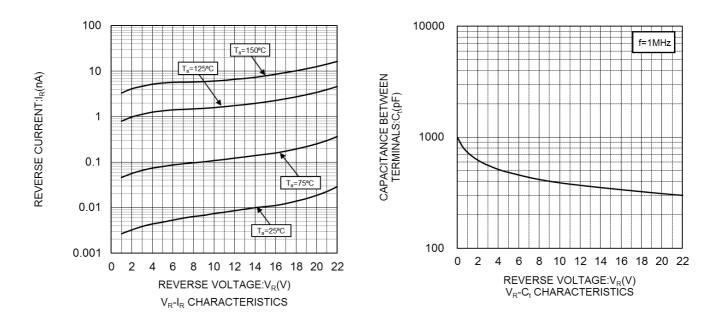
V <sub>Z</sub> Rank(V)	Marking	V <sub>Z</sub> Rank(V)	Marking
5	U2	15	W5
6	V2	16	X5
7	X2	17	T6
8	υ4	18	U6
9	V4	20	V6
10	VV4	22	W6
11	X4	24	X6
12	T5	26	Y6
13	U5	28	W9
14	V5	30	X9



## Characteristic Curves

CLAMPING VOLTAGE:Vcl(V)







100

R<sub>th(j-a)</sub>

R<sub>th(j-c)</sub>

1000

100

10

1

0.1

0.01

0.001 0.01

TRANSIENT THAERMAL IMPEDANCE:R<sub>th</sub>(°C/W)

T<sub>a</sub>=25⁰C

T<sub>a</sub>=-25⁰C

1000

800

R<sub>th(j-a, sat)</sub> : R<sub>th(j-c, sat)</sub> : 61 °C/W 13 °C/W

Substrate conditions: • Material : glass epoxy substrate(FR4) • Size 20mm×20mm×0.8mm • Both side is all covered w/ copper(35um thickness)

1

TIME:t(s)

R<sub>th</sub>-t CHARACTERISTICS

10

100

1000

0.1

## Characteristic Curves

T<sub>a</sub>=125°C

T<sub>a</sub>=75°C

400

600

FORWARD VOLTAGE: V<sub>F</sub>(mV)

V<sub>F</sub>-I<sub>F</sub> CHARACTERISTICS



10

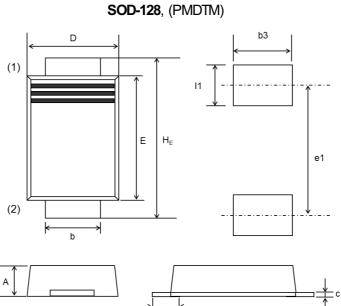
0.1

200





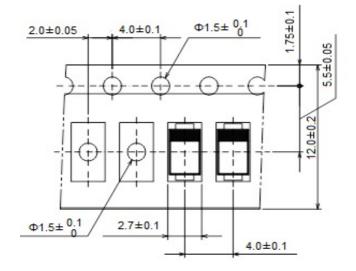
### Dimensions

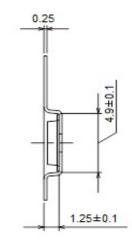


$\rightarrow$ $L_{p}$						
DIM		Milimeters		Inches		
DIN	Min.	Average	Max.	Min.	Average	Max.
А	0.85	0.95	1.05	0.033	0.037	0.041
b	1.30	1.50	1.70	0.051	0.059	0.067
С	0.12	0.17	0.27	0.005	0.007	0.011
D	2.30	2.50	2.70	0.091	0.098	0.106
E	3.50	3.70	3.90	0.138	0.146	0.154
HE	4.56	4.70	4.84	0.180	0.185	0.191
Lp	-	0.75	-	-	0.030	-
11	-	1.40	-	-	0.055	-
b3	-	2.00	-	-	0.079	-
e1	-	4.40	-	-	0.173	-

(1) The marking bar indicates the cathode.(2) The direction indicates the anode.

•Taping (Unit:mm)





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(Note1) Medical Equipment Classification of the Specific Applications
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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
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  - [h] Use of the Products in places subject to dew condensation
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

#### Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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#### **Precaution for Electrostatic**

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

#### Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

#### **Precaution for Product Label**

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